Docket No. **03-211**

Declaration and Power of Attorney For Patent Application English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

	olural names are lis	ntor (if only one name is listed belo sted below) of the subject matter w titled	
BIOMEDICAL SUPERELAS METHOD	TIC TI-BASED ALI	OY, ITS PRODUCT AND ITS MANUF	ACTURING
the specification of which (check one)			
☑ is attached hereto.	•		
us filed on		as United States Application No.	or PCT International
Application Number _			
and was amended on			
•		(if applicable)	
_		erstand the contents of the above in the interest in the content referred to above.	dentified specification,
1.56, including for contin	nuation-in-part app the prior applciation	on which is material to patentability ploiations, material information whon and the national or PCT interna	ich became available
application(s) for patent, international application America, listed below and	inventor's or plar which designated have also identified breeder's rights co	ler 35 U.S.C. 119(a)-(d) or (f), or nt breeder's rights certificate(s), or at least one country other than ed below, by checking the box, any ertificate(s), or any PCT internation which priority is claimed.	the United States of foreign application for
Prior Foreign Application(s	s)		Priority Not Claimed
2003-199412	Japan	18 July 2003	
(Number) 2003-199413	(Country) Japan	(Day/Month/Year Filed) 18 July 2003	_
(Number)	(Country)	(Day/Month/Year Filed)	_
(Number)	(Country)	(Day/Month/Year Filed)	

I hereby claim the benefit under application(s) listed below:	35 U.S.C. Section 119(e)	of any United States provisional
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
(Application Serial No.)	(Filing Date)	
Section 365(c) of any PCT Internations insofar as the subject matter of ear United States or PCT International U.S.C. Section 112, I acknowledge Office all information known to me	onal application designating ch of the claims of this app application in the manner p the duty to disclose to the land to be material to patentable between the filing date of	any United States application(s), or the United States, listed below and, olication is not disclosed in the prior rovided by the first paragraph of 35 United States Patent and Trademark ility as defined in Title 37, C. F. R., the prior application and the national
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

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